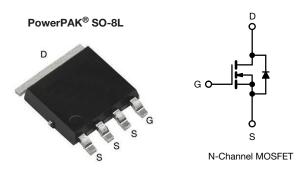
Vishay Siliconix



# **E Series Power MOSFET**



PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	65	50
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.208
Q <sub>g</sub> max. (nC)	2	3
Q <sub>gs</sub> (nC)	2	1
Q <sub>gd</sub> (nC)	6	3
Configuration	Sin	gle

## FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiHJ240N60E-T1-GE3
	SiHJ240N60E-T2-GE3

ABSOLUTE MAXIMUM RATINGS	(T <sub>C</sub> = 25 °C, unless	otherwise	e noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	- V
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	= 25 °C = 100 °C	Ι <sub>D</sub>	12	
	V <sub>GS</sub> at 10 V	= 100 °C		7	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	30	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	81	mJ
Maximum power dissipation			PD	89	W
Operating junction and storage temperature ra	ange		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> =	= 125 °C	dv/dt	100	V/ns
Reverse diode dv/dt <sup>c</sup>	·		av/at	28	V/IIS

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.4 A
- c.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C

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COMPLIANT

HALOGEN

FREE

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# SiHJ240N60E

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	52		65			°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	1.0		1.4			C/W	
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3.0	-	5.0	V
Onto norma la clusica		,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zero gate voltage drain current		V <sub>DS</sub> =	: 600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	μA
	IDSS	V <sub>DS</sub> = 480 V	', V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	١ <sub>c</sub>	<sub>0</sub> = 5.5 A	-	0.208	0.240	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	= 5.5 A	-	4	-	S
Dynamic	•	•			•	•		<b>.</b>
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V		-	783	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 100 V, f = 1 MHz		-	50	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	32	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{\rm DS} = 0$	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	187	-	1
Total gate charge	Qg				-	15	23	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 5.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	4	-	nC	
Gate-drain charge	Q <sub>gd</sub>				-	6	-	
Turn-on delay time	t <sub>d(on)</sub>		•		-	15	30	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub> =	= 5.5 A,	-	14	28	- ns
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>g</sub> =	= 9.1 Ω	-	26	52	
Fall time	t <sub>f</sub>	1			-	14	28	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.8	1.5	3.0	Ω	
Drain-Source Body Diode Characteristi	cs	•			•	•	•	
Continuous source-drain diode current	١ <sub>S</sub>	MOSFET symbol showing the		-	-	12		
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction			-	-	30	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 5.5 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	209	418	ns
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 5.5 A, di/dt = 100 A/μs, V <sub>B</sub> = 25 V		-	2.1	4.2	μC	
Reverse recovery current	I <sub>RRM</sub>		100 Av µ3, N	K - 20 V	-	18	-	Α

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

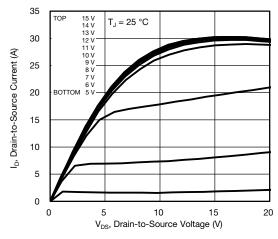
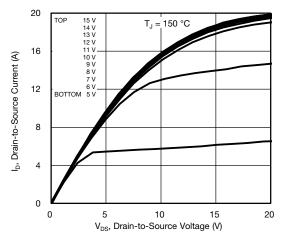


Fig. 1 - Typical Output Characteristics





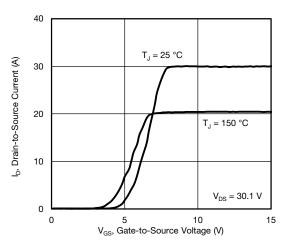


Fig. 3 - Typical Transfer Characteristics

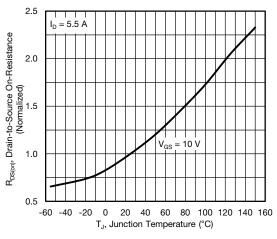


Fig. 4 - Normalized On-Resistance vs. Temperature

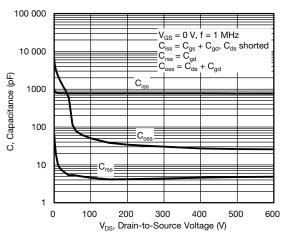


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

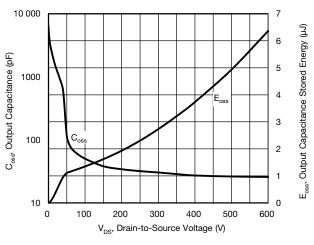


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

S20-0348-Rev. C, 11-May-2020

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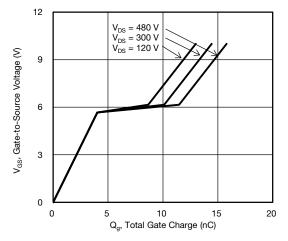


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

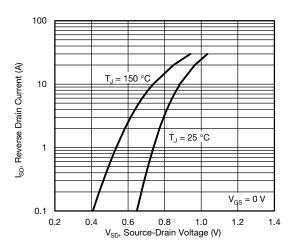
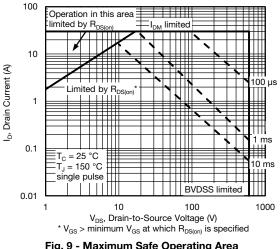


Fig. 8 - Typical Source-Drain Diode Forward Voltage





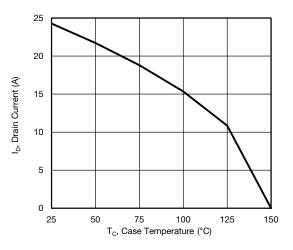


Fig. 10 - Maximum Drain Current vs. Case Temperature

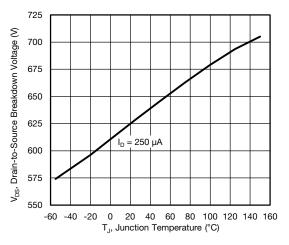


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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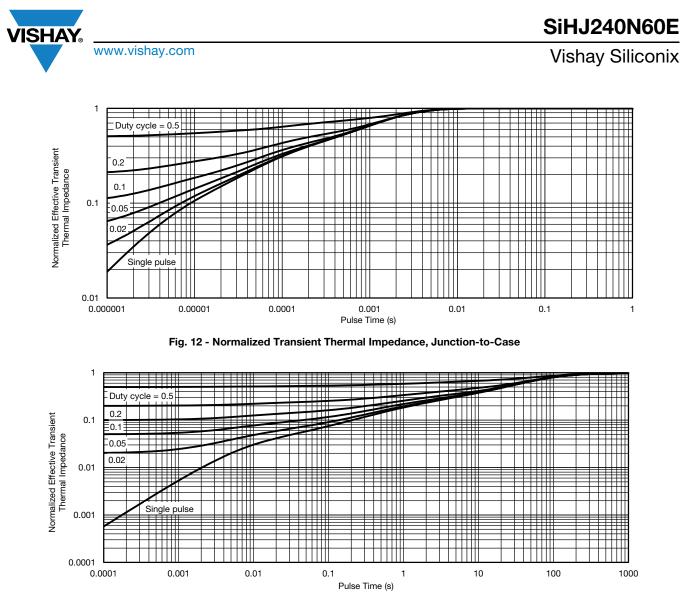


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

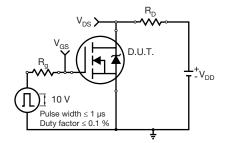


Fig. 14 - Switching Time Test Circuit

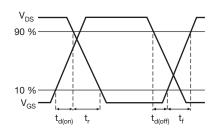


Fig. 15 - Switching Time Waveforms

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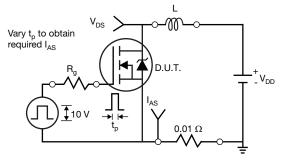


Fig. 16 - Unclamped Inductive Test Circuit

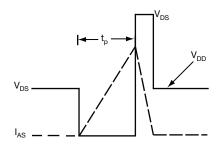


Fig. 17 - Unclamped Inductive Waveforms

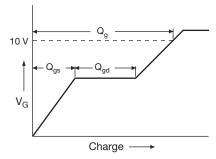


Fig. 18 - Basic Gate Charge Waveform

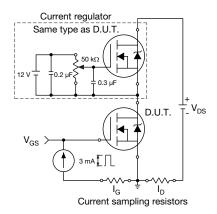


Fig. 19 - Gate Charge Test Circuit

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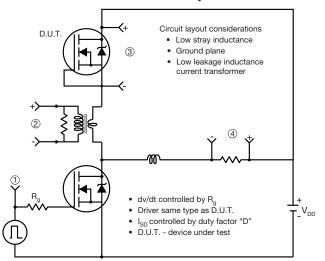
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#### Peak Diode Recovery dv/dt Test Circuit



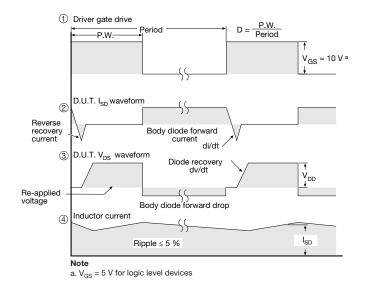


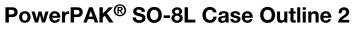
Fig. 20 - For N-Channel

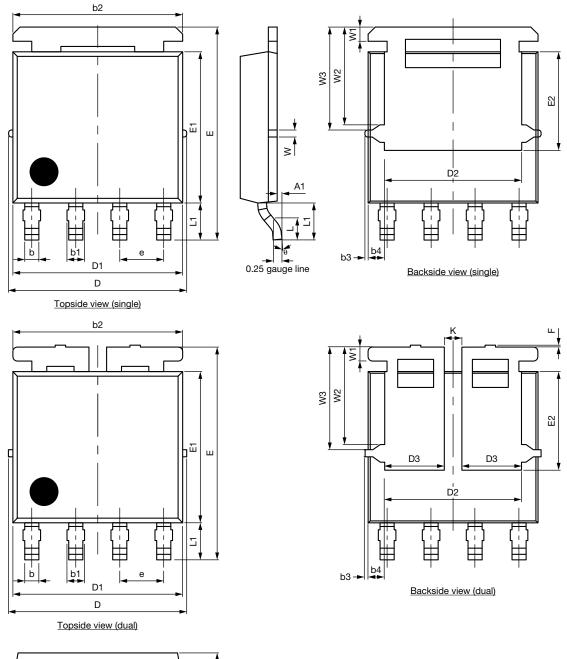
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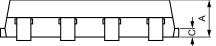
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# **Package Information**



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DIM.		MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN. NOM.		MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51			0.020		
W	0.23			0.009			
W1	0.41			0.016			
W2	2.82			0.111			
W3	2.96			0.117			
θ	0°	-	10°	0°	-	10°	

Note

• Millimeters will govern



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### RECOMMENDED MINIMUM PAD FOR PowerPAK<sup>®</sup> SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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